



### 140Mb/s Bi-directional Level Translator for Push-Pull Applications

#### **Features**

- → 0.85V to 2.7V on A Port and 1.35V to 3.6V on B Port
- → VCCA may be greater than, equal to, or less than VCCB
- → High-Speed with 140 Mb/s Guaranteed Date Rate
- → 100 pF Capacitive Drive Capability
- → Low Bit-to-Bit Skew
- → Overvoltage Tolerant Enable and I/O Pins
- → Non-preferential Power-Up Sequencing
- → Power-Off Protection
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

- → Packaging (Pb-free & Green):
  - 8-pin, UDFN1.2x1.6(XV)
  - 8-pin, MSOP (U)

# **Applications**

- → Mobile Phones, PDAs
- → Other Portable Devices

# **Description**

The PI4ULS3V302 is a 2-bit configurable dual-supply autosensing bidirectional level translator that does not require a direction control pin. The B and A ports are designed to track two different power supply rails, VCCB and VCCA respectively.

The PI4ULS3V302 offers the feature that the values of the VCCB and VCCA supplies are independent. Design flexibility is maximized because VCCA can be set to a value either greater than or less than the VCCB supply.

The PI4ULS3V302 has high output current capability, which allows the translator to drive high capacitive loads such as most high frequency EMI filters. Another feature of the PI4ULS3V302 is that each An and Bn channel can function as either an input or an output.

An Output Enable (EN) input is available to reduce the power consumption. The EN pin can be used to disable both I/O ports by putting them in 3-state which significantly reduces the supply current.

The PI4ULS3V302 is 2 kV System-Level ESD Capable.

# **Block Diagram**

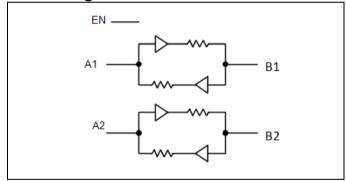


Figure 1: Block Diagram

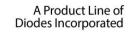
#### Notes

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halógen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

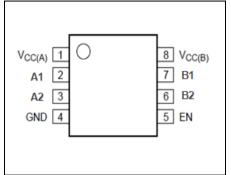






# Pin Configuration (Top View)

1 Vcc(A)	Vcc(B)	8
2 A1	B1	7
3 A2	B2	6
4 GND	EN	5



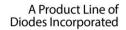
UDFN Package

**MSOP Package** 

**Pin Description** 

Pin#	Pin Name	Type	Description
1	$V_{CC(A)}$	Power	A-port supply voltage. $0.85$ V $\leq$ V <sub>CCA</sub> $\leq$ 2.7 V
2	A1	I/O	Input/output A. Referenced to V <sub>CCA</sub> .
3	A2	I/O	Input/output A. Referenced to V <sub>CCA</sub> .
4	GND	GND	Ground.
5	EN	Input	Output enable (active High). Pull EN low to place all outputs in 3-state mode.
6	B2	I/O	Input/output B. Referenced to V <sub>CCB</sub>
7	B1	I/O	Input/output B. Referenced to V <sub>CCB</sub>
8	V <sub>CCB</sub>	Power	B-port supply voltage. $1.35V \le V_{CCB} \le 3.6V$







# **Maximum Ratings**

Storage Temperature	65°C to +150°C
Junction Temperature, Tj	125°C
DC Supply Voltage port B	0.5V to +4.6V
DC Supply Voltage port A	0.5V to+3.6V
Vi(A) referenced DC Input / Output Voltage	0.5V to +3.6V
Vi(B) referenced DC Input / Output Voltage	0.5V to+4.6V
Enable Control Pin DC Input Voltage	-0.5V to+3.6V
DC Input Diode Current(V <sub>I</sub> <gnd)< td=""><td>50mA</td></gnd)<>	50mA
DC Output Diode Current(V <sub>O</sub> <gnd)< td=""><td>50mA</td></gnd)<>	50mA
DC Supply Current through V <sub>CCB</sub>	±100mA
DC Supply Current through V <sub>CCA</sub>	±100mA
DC Ground Current through Ground Pin	±100mA

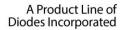
### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

**Recommended Operation Conditions** 

Symbol	Par	Parameter		Typ.	Max.	Unit
$V_{CCA}$	A-side Positive DC Supply Voltage	ge	0.85	-	2.7	V
$V_{CCB}$	B-side Positive DC Supply Voltage	ge	1.35	-	3.6	V
$V_{\rm I}$	Enable Control Pin Voltage		GND	-	2.7	V
V	D. Jan. 4/O. da. 4 Pin Walter	I/O A	GND	-	2.7	V
$V_{IO}$	Bus Input/Output Pin Voltage	I/O B	GND	1	3.6	V
$T_A$	Operating Temperature Range		-40	1	+85	°C
At/Av	Input Transition Rise or Rate, $V_I$ , $V_{IO}$ from 30% to 70% of $V_{CC}$ ; $V_{CC}$ = 3.3 V $\pm$ 0.3 V		0	-	10	ns







# **DC Electrical Characteristics**

G	D	T	*2(\$7)	¥7 *3(¥7)	-40°C	c to +85	°C	TI•4
Sym	Parameter	Test Conditions <sup>*1</sup>	V <sub>CCB</sub> *2(V)	$V_{CCA}^{*3}(V)$	Min.	Typ.*4	Max.	Unit
$V_{IHB}$	B port Input HIGH Voltage	-	1.35-3.6	0.85-2.7	2/3*V <sub>CCB</sub>	-	ı	V
$V_{ILB}$	B port Input LOW Voltage	-	1.35-3.6	0.85-2.7	-	ı	1/3* V <sub>CCB</sub>	V
$V_{IHA}$	A port Input HIGH Voltage	-	1.35-3.6	0.85-2.7	2/3*V <sub>CCA</sub>	1	-	V
V <sub>ILA</sub>	A port Input LOW Voltage	-	1.35-3.6	0.85-2.7	-	-	1/3 * V <sub>CCA</sub>	V
V <sub>IH</sub>	Control Pin Input HIGH Voltage	$T_A = +25$ °C	1.35-3.6	0.85-2.7	2/3*V <sub>CCA</sub>	-	-	V
$V_{IL}$	Control Pin Input LOW Voltage	$T_A = +25$ °C	1.35-3.6	0.85-2.7	-	-	1/3 * V <sub>CCA</sub>	V
V <sub>OHB</sub>	B port Output HIGH Voltage	B port source current = $20\mu A$	1.35-3.6	0.85-2.7	0.9*V <sub>CCB</sub>	-	-	V
V <sub>OLB</sub>	B port Output LOW Voltage	B port sink current = 20μA	1.35-3.6	0.85-2.7	-	-	0.2	V
V <sub>OHA</sub>	A port Output HIGH Voltage	A port source current= 20μA	1.35-3.6	0.85-2.7	0.9*V <sub>CCA</sub>	-	-	V
V <sub>OLA</sub>	A port Output LOW Voltage	A port sink current = 20μA	1.35-3.6	0.85-2.7	-	-	0.2	V
$I_{QVB}$	V <sub>CCB</sub> Supply Current	$EN = V_{CCA}, I_O = 0A,$ $(I/O\_B = 0V \text{ or } V_{CCB}, I/O\_A = \text{float})$	1.35-3.6	0.85-2.7	-	-	1.5	μΑ
$I_{QVA}$	V <sub>CCA</sub> Supply Current	or $(I/O\_B = float, I/O\_A = 0V \text{ or} V_{CCA})$	1.35-3.6	0.85-2.7	-	-	1	μA
I <sub>TS-B</sub>	B port Tristate Output Mode Supply Current	$T_A$ =+25 °C, EN=0V ( I/O_B = 0V or V <sub>CCB</sub> , I/O_A =	1.35-3.6	0.85-2.7	-	-	1.5	μΑ
I <sub>TS-A</sub>	A port Tristate Output Mode Supply Current	float) or ( $I/O\_B = float$ , $I/O\_A = 0V$ or $V_{CCA}$ )	1.35-3.6	0.85-2.7	-	-	0.5	μA
I <sub>oz</sub>	I/O Tristate Output Mode Leakage Current	$T_A = +25$ °C, EN= 0V	1.35-3.6	0.85-2.7	-	-	±1	μΑ
$I_{\rm I}$	Control Pin Input Current	$T_A = +25$ °C	1.35-3.6	0.85-2.7	-	-	±1	μΑ
	Power Off Leakage	$I/O_B = 0$ to 3.6V, $I/O_A = 0$ to	0	0	-	-	2	
$I_{OFF}$	Current	2.5V	1.35-3.6	0	-	-	2	μA
Note:			0	0.85-2.7	-	-	2	

- 1. Normal test conditions are  $V_I = 0V$ ,  $C_{IOB} \le 15 pF$  and  $C_{IOA} \le 15 pF$ , unless otherwise specified.

  2.  $V_{CCB}$  is the supply voltage associated with the I/O B port, and B range from +1.35 V to 3.6 V under normal operating conditions.

  3.  $V_{CCA}$  is the supply voltage associated with the I/O A port, and A range from +0.85 V to 2.7V under normal operating conditions.
- 4. Typical values are for  $V_{CCB} = +2.8V$ ,  $V_{CCA} = +1.8V$  and  $T_A = +25$  °C. All units are production tested at  $T_A = +25$  °C. Limits over the operating temperature range are guaranteed by design.
- 5. When VCCA <1.0V, VIH is  $0.75*V_{CCA}$  (Min) , VIL is  $0.25*V_{CCA}$ (Max)



# A Product Line of Diodes Incorporated

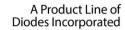


**PI4ULS3V302** 

**Timing Characteristics** 

Crm	Parameter	Test Conditions*1	V *2 (V)	V *3(V)	-40°C to +85°C			Unit
Sym	Parameter	Test Conditions	$V_{CCB}^{*2}(V)$	$V_{CCA}^{*3}(V)$	Min.	Typ.*4	Max.	Unit
t	B port Rise Time	$C_{IOB} = 15 \text{ pF}$	1.35-3.6	0.85-2.7	-	1.4	8.5	ne
t <sub>R-B</sub>	b port Rise Time	C <sub>IOB</sub> = 15 pr	2.5-3.6	1.8-2.7	-	1.4	3.5	ns
t	B port Fall Time	$C_{IOB} = 15 \text{ pF}$	1.35-3.6	0.85-2.7	1	1.2	8.5	ne
t <sub>F-B</sub>	b port rail Time	$C_{IOB} = 13 \text{ pr}$	2.5-3.6	1.8-2.7	1	1.2	3.5	ns
t	A port Rise Time	C - 15 pF	1.35-3.6	0.85-2.7	-	1.3	8.5	no
$t_{R-A}$	A port Rise Time	$C_{IOA} = 15 pF$	2.5-3.6	1.8-2.7	-	1.3	3.5	ns
<b>+</b>	A most Foll Time	C - 15 pE	1.35-3.6	0.85-2.7	-	1.6	8.5	
$t_{F-A}$	A port Fall Time	$C_{IOA} = 15 pF$	2.5-3.6	1.8-2.7	-	1.6	3.5	ns
	B port One-Shot Output Impedance		1.5		-	37	-	
$Z_{OB}$		*5	2.5	0.9-2.5	-	20	-	Ω
			3.6	0.0	-	15	-	
$Z_{OA}$	A port One-Shot Out- put Impedance	*5	1.5-3.3	0.9 1.8	-	52 17	-	Ω
<b>L</b> OA		. 3	1.5-5.5	2.5	-	15	-	52
		G 45 5	1.35-3.6	0.85-2.7	-	-	35	
		$C_{IOB} = 15 \text{ pF}$	2.5-3.6	1.8-2.7	-	_	10	_
			1.35-3.6	0.85-2.7	-	-	35	_
	Propagation Delay	$C_{IOB} = 30 \text{ pF}$	2.5-3.6	1.8-2.7	-	-	10	
PD_A-B	(Driving B port )		1.6-3.6	1.0-2.5	-	_	37	ns
		$C_{IOB} = 50 \text{ pF}$	2.5-3.6	1.8-2.7	-	_	11	-
		$C_{IOB} = 100 \text{ pF}$	1.8-3.6	1.2-2.5	-	_	40	
			2.5-3.6	1.8-2.7	-	_	13	
			1.35-3.6	0.85-2.7	-	_	35	ns
		$C_{IOA} = 15 \text{ pF}$	2.5-3.6	1.8-2.7	-	_	10	
			1.35-3.6	0.85-2.7	-	_	35	
	Propagation Delay	$C_{IOA} = 30 \text{ pF}$	2.5-3.6	1.8-2.7	-	-	10	
PD_B-A	(Driving A port )		1.6- 3.6	1.0-2.5	-	_	37	
		$C_{IOA} = 50 \text{ pF}$	2.5-3.6	1.8-2.7	-	_	11	
			1.8 -3.6	1.2-2.5	-	_	40	
		$C_{IOA} = 100 \text{ pF}$	2.5-3.6	1.8-2.7	-	-	13	
t <sub>SK</sub>	Channel-to-Channel Skew	$C_{IOB} = 15pF, \ C_{IOA} = 15pF^{*5}$	1.35-3.6	0.85-2.7	-	-	0.15	ns
t <sub>EN-B</sub>		C 15 F 1/O 1 1/	1.35-3.6	0.85-2.7	-	240	400	
$(t_{PZH})$	B port Output Enable	$C_{IOB} = 15pF$ , $I/O\_A = V_{CCA}$	2.5-3.6	1.8-2.7	-	-	160	
t <sub>EN-B</sub>	Time		1.35-3.6	0.85-2.7	-	80	150	ns
$(t_{PZL})$		$C_{IOB} = 15pF, I/O\_A = 0V$	2.5-3.6	1.8-2.7	-	-	130	
t <sub>EN-A</sub>		C 15 F 10 P W	1.35-3.6	0.85-2.7	-	130	250	
$(t_{PZH})$	A port Output Enable	$C_{IOA} = 15pF, I/O\_B = V_{CCB}$	2.5-3.6	1.8-2.7	-	-	160	
t <sub>EN-A</sub>	Time	G 45 EVO B 0V	1.35-3.6	0.85-2.7	-	100	200	ns
$(t_{PZL})$		$C_{IOA} = 15 \text{ pF}, I/O\_B = 0 \text{ V}$	2.5-3.6	1.8-2.7	-	-	130	
t <sub>OIS-B</sub>		C 15 E 1/O A M	1.35-3.6	0.85-2.7	-	-	210	
$(t_{PHZ})$	B port Output Disable	$C_{IOB} = 15pF$ , $I/O\_A = V_{CCA}$	2.5-3.6	1.8-2.7	-	-	210	
t <sub>OIS-B</sub>	Time		1.35-3.6	0.85-2.7	-	-	175	ns
$(t_{PLZ})$		$C_{IOB} = 15pF, I/O\_A = 0V$	2.5-3.6	1.8-2.7	-	-	175	
t <sub>OIS-B</sub>		O 15 E 1/O A 37	1.35-3.6	0.85-2.7	-	-	210	
$(t_{PHZ})$	A port Output	$C_{IOB} = 15pF$ , $I/O\_A = V_{CCA}$	2.5-3.6	1.8-2.7	-	_	210	
t <sub>OIS-B</sub>	Disable Time	O 15 E 1/O 1 011	1.35-3.6	0.85-2.7	-	_	175	ns
$(t_{PLZ})$		$C_{IOB} = 15pF, I/O\_A = 0V$	2.5-3.6	1.8-2.7	-	-	175	1







**Timing Characteristics (Cont.)** 

Sym	Parameter	Test Conditions*1	V <sub>CCB</sub> *2 (V)	V <sub>CCA</sub> *3(V)	-40	°C to +85	°C	Unit
Sym	rarameter	Tarameter Test Conditions CCB (*)	V <sub>CCB</sub> (V)	V <sub>CCA</sub> (V)	Min.	Typ.*4	Max.	Omt
		C - 15pF	1.35-3.6	0.85-2.7	50	-	-	
	Maximum Data Rate -	$C_{IO} = 15pF$	2.5-3.6	1.8-2.7	140	-	-	
		$C_{IO} = 30 pF$ $C_{IO} = 50 pF$ $C_{IO} = 100 pF$	1.35-3.6	0.85-2.7	40	-	-	
M			2.5-3.6	1.8-2.7	120	-	-	mhna
$M_{ m IDR}$			1.6-3.6	1.0-2.7	30	-	-	mbps
			2.5-3.6	1.8-2.7	100	-	-	
			1.8-3.6	1.2-2.7	20	-	-	
		C <sub>IO</sub> = 100pr	2.5-3.6	1.8-2.7	60	-	-	

- 1. Normal test conditions are  $V_I = 0$  V,  $C_{IOB} \le 15 pF$  and  $C_{IOA} \le 15 pF$ , unless otherwise specified.
- V<sub>CCB</sub> is the supply voltage associated with the I/O B port, and B ranges from +1.35 V to 3.6 V under normal operating conditions.
   V<sub>CCA</sub> is the supply voltage associated with the I/O A port, and A ranges from +0.85 V to 2.7V under normal operating conditions.
- 4. Typical values are for B = +2.8V, A = +1.8V and  $T_A = +25$  °C. All units are production tested at  $T_A = +25$  °C. Limits over the operating temperature range are guaranteed by design.

# Power Consumption (T<sub>A</sub>=+25°C)

Sym <sup>*1</sup>	Parameter	Test Conditions	$V_{CCB}^{*2}(V)$	$V_{CCA}^{*3}(V)$	Тур.	Unit
C	A = Input port, B = Output Port	$C_{Load} = 0$ , $f = 1MHz$ ,	1.35-3.6	0.85-2.7	40	pF
C <sub>PD_VCCA</sub>	B = Input port, A = Output Port	$EN = V_{CCA}$ (outputs enabled)	1.33-3.0	0.63-2.7	40	pr
C	A = Input port, B = Output Port	$C_{Load} = 0$ , $f = 1MHz$ ,	1.35-3.6	0.85-2.7	40	nΕ
C <sub>PD_VCCB</sub>	B = Input port, A = Output Port	$EN = V_{CCA}$ (outputs enabled)	1.33-3.0	0.03-2.7	40	pF
C <sub>PD_VCCA</sub>	A = Input port, B = Output Port B = Input port, A =	$C_{Load} = 0$ , $f = 1MHz$ , EN = GND(outputs disabled)	1.35-3.6	0.85-2.7	1	pF
	Output Port A = Input port, B =					
C <sub>PD_VCCB</sub>	Output Port  B = Input port, A =  Output Port	$C_{Load} = 0$ , $f = 1MHz$ , EN = GND(outputs disabled)	1.35-3.6	0.85-2.7	1	pF

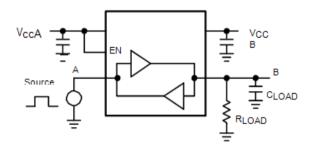
- $2.V_{CCB}$  is the supply voltage associated with the I/O B port, and  $V_{CCB}$  ranges from +1.35V to 3.6V under normal operating conditions.
- $3.V_{CCA}$  is the supply voltage associated with the I/O A port, and  $V_{CCA}$  range from +0.0.85 V to 2.7V under normal operating conditions.
- 4. Typical values are at  $T_A = +25$  °C.

<sup>1.</sup>C<sub>PD VCCA</sub> and C<sub>PD VCCB</sub> are defined as the value of the IC's equivalent capacitance from which the operating current can be calculated for the A and B power supplies, respectively.  $I_{CC} = I_{CC}$  (dynamic) +  $I_{CC}$  (static)  $\approx I_{CC}$  (operating)  $\approx$ CPD x  $V_{CC}$  x  $f_{IN}$  x NSW where  $I_{CC} = I_{CC}$   $V_{CCB} + I_{CC}$   $V_{CCA}$  and NSW = total number of outputs





## **Test Circuits**



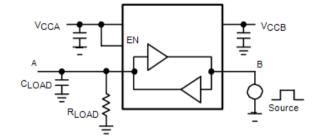


Figure 2. Driving A Test Circuit

Figure 3. Driving B Test Circuit

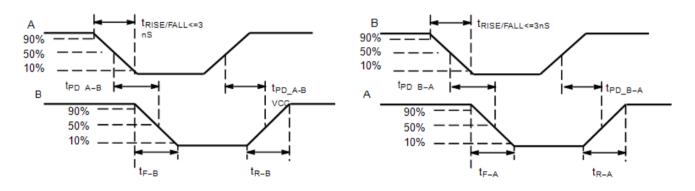
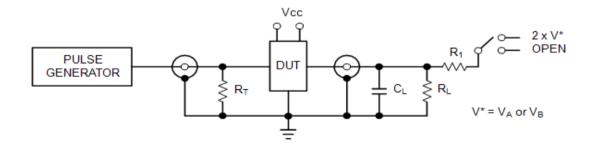


Figure 4. Definition of Timing Specification Parameters



Test	Switch
t <sub>PZH</sub> , t <sub>PHZ</sub>	Open
t <sub>PZL</sub> , t <sub>PLZ</sub>	2 x V*

 $C_L$  = 15 pF or equivalent (Includes jig and probe capacitance)  $R_L$  =  $R_1$  = 50 k  $\Omega$  or equivalent

 $R_T = Z_{OUT}$  of pulse generator (typically 50  $\Omega$ ) V\* = V<sub>A</sub>or V<sub>B</sub> for A or B measurements, respectively.

Figure 5. Test Circuit for Enable/Disable Time Measurement



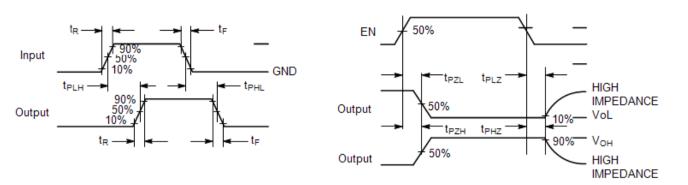


Figure 6. Timing Definitions for Propagation Delays and Enable/Disable Measurement

# **Functional Description**

The PI4ULS3V302 is a 2-bit configurable dual-supply autosensing bidirectional level translator that does not require a direction control pin. The B and A ports are designed to track two different power supply rails, VCCB and VCCA respectively.

The PI4ULS3V302 offers the feature that the values of the VCCB and  $V_{CCA}$  supplies are independent. Design flexibility is maximized because VCCA can be set to a value either greater than or less than the VCCB supply.

The PI4ULS3V302 has high output current capability, which allows the translator to drive high capacitive loads such as most high frequency EMI filters. Another feature of the PI4ULS3V302 is that each An and Bn channel can function as either an input or an output.

An Output Enable (EN) input is available to reduce the power consumption. The EN pin can be used to disable both I/O ports by putting them in 3-state which significantly reduces the supply current.

# **Application Information**

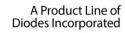
#### **Level Translator Architecture**

The PI4ULS3V302 auto-sense translator provides bi-directional logic voltage level shifting to transfer data in multiple supply voltage systems. These level translators have two supply voltages, VCCA and VCCB, which set the logic levels on the input and output sides of the translator. When used to transfer data from the I/O VCCA to the I/O VCCB ports, input signals referenced to the VCCA supply are translated to output signals with a logic level matched to VCCB. In a similar manner, the I/O VCCB to I/O VCCA translation shifts input signals with a logic level compatible to VCCB to an output signal matched to VCCA. The PI4ULS3V302 translator consists of bi-directional channels that independently determine the direction of the data flow without requiring a directional pin. One-shot circuits are used to detect the rising or falling input signals. In addition, the one-shots decrease the rise and fall times of the output signal for high-to-low and low-to-high transitions.

### **Input Driver Requirements**

Auto-sense translators such as the PI4ULS3V302 have a wide bandwidth, but a relatively small DC output current rating. The high bandwidth of the bi-directional I/O circuit is used to quickly transform from an input to an output driver and vice versa. The I/O ports have a modest DC current output specification so that the output driver can be over driven when data is sent in the opposite direction. For proper operation, the input driver to the auto-sense translator should be capable of driving 3mA of peak output current. The bi-directional configuration of the translator results in both input stages being active for a very short time period. Although the peak current from the input signal circuit is relatively large, the average current is small and consistent with a standard CMOS input stage. Enable Input (EN) The PI4ULS3V302 translator has an Enable pin (EN) that provides tri–state operation at the I/O pins. Driving the Enable pin to a low logic level minimizes the power consumption of the device and drives the I/O VCCB and I/O VCCA pins to a high impedance state. Normal translation operation occurs when the EN pin is equal to a logic high signal. The EN pin is referenced to the VCCA supply and has Over-Voltage Tolerant (OVT) protection.







#### **Uni-Directional versus Bi-Directional Translation**

The PI4ULS3V302 translator can function as a non-inverting uni-directional translator. One advantage of using the translator as a uni-directional device is that each I/O pin can be configured as either an input or output. The configurable input or output feature is especially useful in applications such as SPI that use multiple uni-directional I/O lines to send data to and from a device. The flexible I/O port of the auto sense translator simplifies the trace connections on the PCB.

### **Power Supply Guidelines**

The values of the VCCA and VCCB supplies can be set to anywhere in range 0.85-2.7V and 1.35-3.6V. Design flexibility is maximized because VCCA may be either greater than or less than the VCCB supply. The sequencing of the power supplies will not damage the device during power-up operation. In addition, the I/O VCCB and I/O VCCA pins are in the high impedance state if either supply voltage is equal to 0V. For optimal performance, 0.01 to  $0.1\mu F$  decoupling capacitors should be used on the VCCA and VCCB power supply pins. Ceramic capacitors are a good design choice to filter and bypass any noise signals on the voltage lines to the ground plane of the PCB. The noise immunity will be maximized by placing the capacitors as close as possible to the supply and ground pins, along with minimizing the PCB connection traces. The PI4ULS3V302 translators have a power down feature that provides design flexibility. The output ports are disabled when either power supply is off (VCCA or VCCB = 0V). This feature causes all of the I/O pins to be in the power saving high impedance state.

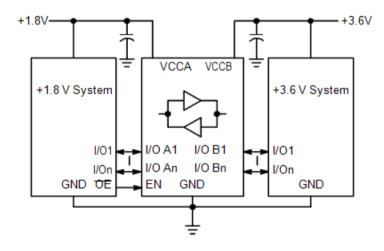
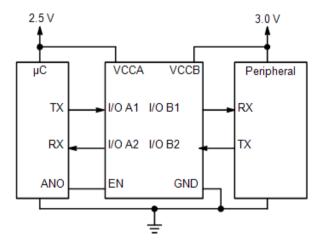
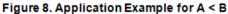


Figure 7. Typical Application Circuit





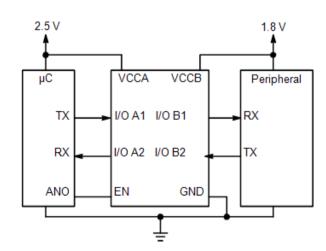
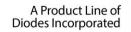


Figure 9 Application Example for A > B



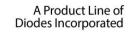




# **Part Marking**

Top mark not available at this time. To obtain advance information regarding the top mark, please contact your local sales representative.

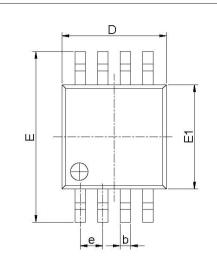


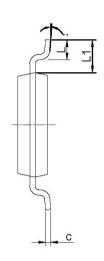


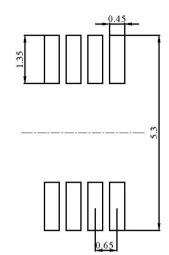


# **Packaging Mechanical**

8-MSOP (U)

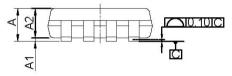






51/0 5		0000	
PKG D	IMENSION	S(MM)	
SYMBOL	Min.	Max.	
А	=	1.10	
A1	0.00	0.15	
A2	0.75	0.95	
b	0.22	0.38	
С	0.08	0.23	
D	2.80	3.20	
E	4.65	5.15	
E1	2.80	3.20	
е	0.65 BSC		
L	0.40	0.80	
L1	0.95 REF		
θ	0°	8°	

RECOMMENDED LAND PATTERN(unit:mm)

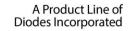


- NOTE:
  1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.
  2. REFER JEDEC MO-187F/AA
  3. PACKAGE OUTLINE DIMENSIONS DO NOT INCLUDE MOLD FLASH AND METAL BURR.
  4. LAND PATTERN REFERENCE DIODES MSOP-8 PACKAGE INFORMATION.

DIODES.	PERICON A MEDIAN IMPORTANT PROPERTY IN PRO	DATE: 11/04/19	
DESCRIPTION: 8-Pin, M	ini Small Outline Package, MSOF	•	
PACKAGE CODE: U (U8)			
DOCUMENT CONTROL #: PD-1261		REVISION: H	

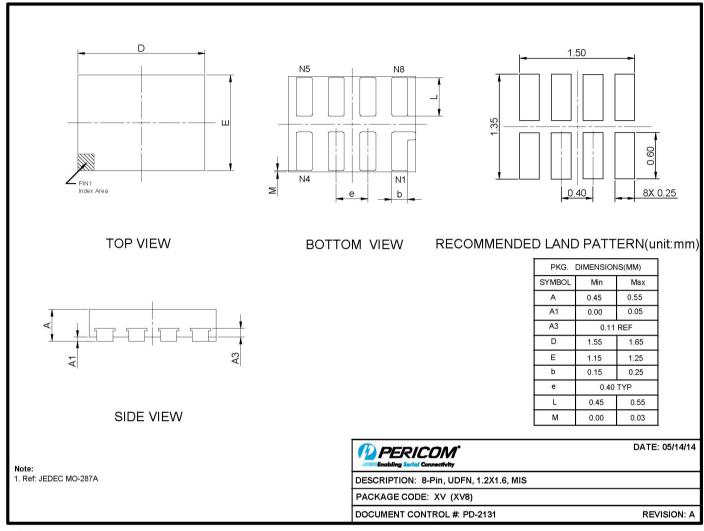
19-1147







#### 8-UDFN (XV)



14-0141

#### For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

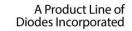
# **Ordering Information**

Part Number	Package Code	Package Description
PI4ULS3V302UEX	U	8-Pin, Mini Small Outline Package (MSOP)
PI4ULS3V302XVEX	XV	8-Pin, 1.2x1.6, MIS (UDFN)

#### **Notes:**

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
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- 5. X suffix = Tape/Reel







May 2021

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